FORM;2TO-1449

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(USE SEVERAL SHEETS IF NECESSARY)

ATTY, DOCKET, NO MICRON,003C1

JUN 2 5 1999

APPLICANT Fazan et al.

FILING DATE March 10, 1998 GROUP 2827

APPLICATION NO.

09/037,945

			U.S. PATENT DOCUMENTS			
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPROPRIATE)
·(F	4,243,435	01/06/81	Barile et al.			
. ():	4,247,343	01/27/81	Kruzhanov et al.			
(2)	4,290,184	09/22/81	Kuo			· · ·
, (F	4,551,910	11/12/85	Patterson	29	576	
()	4,979,803	12/25/90	McGuckin et al.			
(3	5,134,089	7/28/92	Barden et al.	437	70	
(5)	5,151,381	9/29/92	Liu et al.	437	69	
(3)	5,218,214	06/08/93	Tyson et al.			
6	5,543,343	08/06/96	Bryant et al.	_	~	
(+)	5,637,528	06/10/97	Higashitani et al.	_		
			RECE	VE	D-	
*		<u> </u>		2 1990		

			FOREIGN PATENT DOCUMENTS TECHNOLOGY	ENTER 2	800			
EXAMINER	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSL	TRANSLATION	
INITIAL	 					YES	NO	
		·						

EXAMINER INITIAL	OTHER DOCUMENTS (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)
(F	Kooi, et al., "Formation of Silicon Nitride at a Si-SiO ₂ Interface during Local Oxidation of Silicon and during Heat-Treatment of Oxidized Silicon in NH ₃ Gas", J. Electrochem Soc. SOLID-STATE SCIENCE AND TECHNOLOGY, July 1976, Vol. 123, No. 7, pgs. 1117-1120 Van Zant, Microchip Fabrication; A Practical Guide to Semiconductor Processing, McGraw-Hill, 1997, p. 159-160, 593.

EXAMINER		FOURSON	ن
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DATE CONSIDERED

10/20/02

*EXAMINER: INITIAL IF CITATION CONSIDERED, WHETHER OR NOT CITATION IS IN CONFORMANCE WITH MPEP 609; DRAW LINE THROUGH CITATION IF NOT IN CONFORMANCE AND NOT CONSIDERED, INCLUDE COPY OF THIS FORM WITH NEXT COMMUNICATION TO APPLICANT.